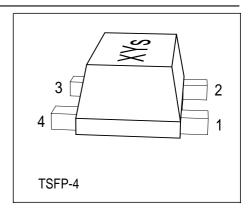
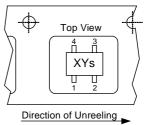


NPN Silicon Germanium RF Transistor*

- High gain ultra low noise RF transistor
- Provides outstanding performance for a wide range of wireless applications up to 10 GHz
- Ideal for CDMA and WLAN applications
- Outstanding noise figure F = 0.5 dB at 1.8 GHz Outstanding noise figure F = 0.75 dB at 6 GHz
- High maximum stable gain
 G_{ms} = 27.5 dB at 1.8 GHz
- Gold metallization for extra high reliability
- 150 GHz f_T-Silicon Germanium technology
- * Short-term description





ESD: Electrostatic discharge sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration				Package		
BFP740F	R7s	1=B	2=E	3=C	4=E	-	-	TSFP-4

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}		V
$T_{A} > 0$ °C		4	
$T_{A} \le 0$ °C		3.5	
Collector-emitter voltage	V _{CES}	13	
Collector-base voltage	$V_{\rm CBO}$	13	
Emitter-base voltage	V _{EBO}	1.2	
Collector current	I_{C}	30	mA
Base current	I _B	3	
Total power dissipation ¹⁾	P_{tot}	160	mW
<i>T</i> _S ≤ 90°C			
Junction temperature	$T_{\rm j}$	150	°C
Ambient temperature	T_{A}	-65 150	
Storage temperature	$T_{\rm stg}$	-65 150	

 $^{^{1}}T_{
m S}$ is measured on the collector lead at the soldering point to the pcb



Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 370	K/W

Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit		
		min.	typ.	max.			
DC Characteristics							
Collector-emitter breakdown voltage	V _{(BR)CEO}	4	4.7	-	V		
$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$							
Collector-emitter cutoff current	I _{CES}	-	-	30	μA		
$V_{CE} = 13 \text{ V}, \ V_{BE} = 0$							
Collector-base cutoff current	I _{CBO}	-	-	100	nA		
$V_{CB} = 5 \text{ V}, I_{E} = 0$							
Emitter-base cutoff current	/ _{EBO}	-		3	μΑ		
$V_{\text{EB}} = 0.5 \text{ V}, I_{\text{C}} = 0$							
DC current gain	h _{FE}	160	250	400	-		
$I_{\rm C} = 25 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}$							

 $^{^{1}\}mbox{For calculation of }\mbox{\it R}_{\mbox{\scriptsize thJA}}$ please refer to Application Note Thermal Resistance



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter Parameter $I_A = 25^{\circ}$ C, unless	Symbol	Values			Unit		
	1	min.	typ.	max.]		
AC Characteristics (verified by random sampling)							
Transition frequency	f_{T}	-	42	-	GHz		
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 3 V, f = 1 GHz							
Collector-base capacitance	C_{cb}	-	0.08	-	pF		
$V_{CB} = 3 \text{ V}, f = 1 \text{ MHz}$							
Collector emitter capacitance	C _{ce}	-	0.25	-			
$V_{CE} = 3 \text{ V}, f = 1 \text{ MHz}$							
Emitter-base capacitance	C _{eb}	-	0.45	-			
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}$							
Noise figure	F				dB		
$I_{C} = 8 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1.8 \text{ GHz}, Z_{S} = Z_{Sopt}$		-	0.5	-			
$I_{C} = 8 \text{ mA}, V_{CE} = 3 \text{ V}, f = 6 \text{ GHz}, Z_{S} = Z_{Sopt}$		-	0.75	-			
Power gain, maximum stable ¹⁾	G _{ms}	-	27.5	-	dB		
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,							
$Z_{L} = Z_{Lopt}$, $f = 1.8 \text{ GHz}$							
Power gain, maximum available ¹⁾	G _{ma}	-	19	-	dB		
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,							
$Z_L = Z_{Lopt}, f = 6 \text{ GHz}$							
Transducer gain	$ S_{21e} ^2$				dB		
$I_{C} = 25 \text{ mA}, \ V_{CE} = 3 \text{ V}, \ Z_{S} = Z_{L} = 50 \ \Omega,$							
f = 1.8 GHz		-	25	-			
$I_{\rm C} = 25 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \ \Omega,$							
f = 6 GHz		-	14.5	-			
Third order intercept point at output ²⁾	IP ₃	-	26	-	dBm		
$V_{CE} = 3 \text{ V}, I_{C} = 25 \text{ mA}, f = 1.8 \text{ GHz},$							
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$							
1dB Compression point at output	P _{-1dB}	-	12	-			
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,							
f = 1.8 GHz							

 $^{^{1}}G_{\mathsf{ma}} = |S_{21e} \, / \, S_{12e}| \; (\mathsf{k}\text{-}(\mathsf{k}^{2}\text{-}1)^{1/2}), \; G_{\mathsf{ms}} = |S_{21e} \, / \, S_{12e}|$

²IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz

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